PATENT COOPERATION TREATY

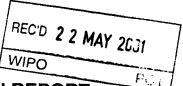
BEST AVAILABLE COPY	From the INTERNATIONAL BUREAU
PCT	То:
NOTIFICATION OF ELECTION (PCT Rule 61.2)	Assistant Commissioner for Patents United States Patent and Trademark Office Box PCT Washington, D.C.20231 ETATS-UNIS D'AMERIQUE
Date of mailing (day/month/year) 04 October 2000 (04.10.00)	in its capacity as elected Office
International application No. PCT/ZA00/00019	Applicant's or agent's file reference PCT/2000/031
International filing date (day/month/year) 08 February 2000 (08.02.00)	Priority date (day/month/year) 08 February 1999 (08.02.99)
Applicant MABOKA, Sydney	
in a notice effecting later election filed with the Inte	ary Examining Authority on:
The International Bureau of WIPO 34, chemin des Colombettes 1211 Geneva 20, Switzerland	Authorized officer R. Forax
Facsimile No.: (41-22) 740.14.35	Telephone No.: (41-22) 338.83 38

Form PCT/IB/331 (July 1992)

09/890917

PATENT COOPERATION TREATY

PCT



INTERNATIONAL PRELIMINARY EXAMINATION REPORT

(PCT Article 36 and Rule 70)

Applicant's	or agent's file reference		
PCT/200	•	FOR FURTHER ACTION	See Notification of Transmittal of International Preliminary Examination Report (Form PCT/IPEA/416)
Internation	al application No.	International filing date (day/month	//year) Priority date (day/month/year)
PCT/ZA	00/00019	08/02/2000	08/02/1999
C08L97/	al Patent Classification (IPC) or 02	national classification and IPC	
Applicant SAPPI L	IMITED et al		
	international preliminary exa s transmitted to the applican		by this International Preliminary Examining Authority
2. This	REPORT consists of a total	of 5 sheets, including this cover sl	neet.
<u>t</u>	een amended and are the b	asis for this report and/or sheets of 607 of the Administrative Instruction	e description, claims and/or drawings which have ontaining rectifications made before this Authority ons under the PCT).
3. This r	eport contains indications re	lating to the following items:	
1	Basis of the report		
B	☐ Priority		
III			entive step and industrial applicability
IV V	 ☐ Lack of unity of inven ☐ Reasoned statement 		novelty, inventive step or industrial applicability;
•		tions suporting such statement	ioventy, inventive step of industrial applicability,
VI	☐ Certain documents c	ited	
VII		international application	*
VIII	☐ Certain observations	on the international application	
Date of sub	mission of the demand	Date of c	ompletion of this report
21/08/20	00	18.05.20	01
	nailing address of the internation examining authority:	nal Authorize	od officer
9)	European Patent Office D-80298 Munich Tel. +49 89 2399 - 0 Tx: 5236.	Ehrenre	eich, W
	Fax: +49 89 2399 - 4465	Telephon	e No. +49 89 2399 8675

INTERNATIONAL PRELIMINARY EXAMINATION REPORT

International application No. PCT/ZA00/00019

l. Basis	of the	report
----------	--------	--------

1.	the and	receiving Office in I	nents of the international response to an invitation o this report since they do	under Article 14 are	referred to in this	ch have been furnished to report as "originally filed" 6 and 70.17)):
	1-13	3	as received on	16/03/2001	with letter of	15/03/2001
	Cla	ims, No.:				
	1-10	6	as received on	16/03/2001	with letter of	15/03/2001
2.	lang	guage in which the i	juage, all the elements m international application v available or furnished to t	vas filed, unless othe	erwise indicated ur	
		• •	translation furnished for t			n (under Rule 23.1(b)).
		• • •				y examination (under Rule
3.		•	leotide and/or amino ad y examination was carrie			
		contained in the in	ternational application in	written form.		
		filed together with	the international applicati	ion in computer read	able form.	
		furnished subsequ	ently to this Authority in v	vritten form.		
		furnished subsequ	ently to this Authority in o	computer readable fo	orm.	
			t the subsequently furnisl oplication as filed has be		e listing does not g	o beyond the disclosure in
		The statement that listing has been full		d in computer readat	ole form is identica	I to the written sequence
4.	The	amendments have	resulted in the cancellat	ion of:		
		the description,	pages:			
		the claims,	Nos.:			
		the drawings,	sheets:			
5.			en established as if (som eyond the disclosure as		ts had not been m	ade, since they have been

INTERNATIONAL PRELIMINARY **EXAMINATION REPORT**

International application No. PCT/ZA00/00019

(Any replacement sheet containing such amendments must be referred to under item 1 and annexed to this report.)

- 6. Additional observations, if necessary:
- V. Reasoned statement under Article 35(2) with regard to novelty, inventive step or industrial applicability; citations and explanations supporting such statement
- 1. Statement

Novelty (N)

Yes:

Claims 1-12,14,15

Inventive step (IS)

No: Yes:

Claims 1-12,14,15 Claims

Industrial applicability (IA)

No: Yes:

Claims 1-16

Claims 13,16

Claims No:

2. Citations and explanations see separate sheet

Ad Item V

Novelty, Art. 33(2):

None of the prior art documents disclose the binding mixture claimed including

- urea-formaldehyde (UF) resin
- MDI
- one or more catalysts selected from a) or b) as claimed in claim 1.

Therefore, the binding mixture claimed in claims 1-12, the process for preparing chipboard using the above bindig mixture according to claim 14 and 15 and the chipboard of claim 16, as far as the claim refers back to claims 1-12,14,15, are novel.

The wording of claim 13 "an additive for a UF binding mixture for use ... the additive including ... MDI and a catalyst ..." has to be understood such that the MDI/catalyst mixture according to original claim 1 is claimed because features like "for use as" or "suitable for" merely define a result to be achieved and do not limit the scope of a product claim.

The subject-matter of claim 13 is therefore not novel vis à vis D1 (WO-A 94/05475, claims 1-3,5-10 in context with p. 4, second para to p. 7, second para and the example of p. 8), D2 (EP-A 0 346 059, claims 1,5; p. 3, II. 10-22 and examples 9,10), D3 (EP-A 0 039 137, claims 2,3,8 in context with p. 4, II. 4-30). The same applies to claim 16 as far it refers back to claim 13.

Inventive step, Art. 33(3):

Closest prior art is D1 disclosing a binding mixture for use in manufacturing chipboard, the mixture including an effective amount of MDI and one or more polyurethane catalysts selected from tertiary amines, hydroxyamines or ether amines. The MDI may be water-emulsifiable and the catalyst may be a delayed-action catalyst. D1 also discloses a process for manufacturing chipboard, the process including adding to or using in a binding mixture an effective amount of MDI and a catalyst as mentioned above and mixing the binding mixture with wood particles.

The subject-matter claimed differs therefrom in that UF resin has in addition been used. There is no indication either in D1 or in D2/D3 that would motivate a person skilled in the art to add UF resins to the above MDI/catalyst binding mixture in order to produce

1

chipboard. Thus, the subject-matter of claims 1-12,14,15 is based on an inventive step.



WORLD INTELLECTUAL PROPERTY ORGANIZATION International Bureau



INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

51) International Patent Classification 7 : C08L 97/02, C08G 18/16	A1	(11) International Publication Number: WO 00/46306 (43) International Publication Date: 10 August 2000 (10.08.00)
(21) International Application Number: PCT/Z/ (22) International Filing Date: 8 February 2000 (30) Priority Data: 99/0969 8 February 1999 (08.02.99) (71) Applicant (for all designated States except US): SA ITED [ZA/ZA]; 6th Floor, Sappi House, 48 Ames Braumfontein. 2017 Johannesburg (ZA). (72) Inventor; and (75) Inventor/Applicant (for US only): MABOKA [ZA/ZA]; 20 Cathedral Street, 6529 George (ZA (74) Agent: D.M. KISCH INC.; P.O. Box 781218, 214 (ZA).	APPI LII hof Stree A, Sydr	BR, BY, CA, CH, CN, CR, CU, CZ, DE, DR, DN, LE, DN, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, TZ, UA, UG US, UZ, VN, YU, ZA, ZW, ARIPO patent (GH, GM, KE LS, MW, SD, SL, SZ, TZ, UG, ZW), Eurasian patent (AM AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU MC, NL, PT, SE), OAPI patent (BF, BJ, CF, CG, CI, CM GA, GN, GW, ML, MR, NE, SN, TD, TG). Published With international search report.

(57) Abstract

This invention provides a binding mixture for use in manufacturing chipboard, the mixture including an effective amount of methyl di-isocyanate ("MDI") and one or more polymethane catalyst(s) being selected from the following: (a) one or more amine compound(s) including aliphatic and aromatic tertiary amine derivatives of phenols, esters, ethers, alkenes and/or alcohols, or (b) one or more organometallic compounds of tin, bismuth, zinc, iron, and/or alkali moral salt(s); or (c) suitable mixtures of (a) and (b) above.

FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

ÁL	Albania	ES	Spain	LS	Lesotho	· 84	Slovenia
AM	Amoria	PI	Finland	LT	Litrania	SK	Slovakia.
AT	Austria	FR	France	LU	Linembourg	SN	Senegal
ΑÜ	Australia	GA	Gabon	LV	Lavis	52	Swaziland
AZ	Azerbaijas	GB	United Kingdom	MC	Monaco	TO	Ched
BA	Boson and Herzegovina	GE	Georgia	MD	Republic of Moldova	TG	Togo
BB	Barbados	GH	Citana	MC	Madagascar	TJ	Tapkissan
BE	Belgium	GN	Guinca	MK	The former Yugoslav	TM	Turkmenium
BF	Burking Faso	GR	Greece		Republic of Macedonia	TR	Turkey
BC	Bulgeria	Hυ	Hungary	ML	Mali	TT	Trinidad and Tobago
B.J	Benin	m	Ireland	MN	Mongolia	UA	Ultraine
BR	Brazil	IL	turael	MR	Manriomia	UG	Uganda
BY	Belaros	ıs	lecland	MW	Malawi	us	United States of America
CA	Canada	IT	İtaly	MX	Mexico	υz	Uzbekistan
CF	Course African Republic	JP	Japan	NE	Niger	VN	Viet Nato
€CG	Congo	KE	Kenya	NL	Netherlands	YU	Yugoslavia
CH	Swizzrland	KG	Kyrgyzstan	NO	Norway	ZW	Zimbabwe
a	Obe d'Ivoire	KP	Democratic People's	NZ	New Zealand .		
CM	Canicmon		Republic of Korca	PL	Poland .		
CN:	China	KR	Republic of Korea	PT.	Portugal		
CU	Cuba	K2	Kazakuran	RO	Romania		
cz	Czech Republic	LC	Saint Lucis	RU	Russian Pederation		
DB	Germany	u	Liechtenstein	SD	Sudan		•
DK	Denmark	LK	Sri Lanka	SE	Sweden		
£Σ	6socia	LR	Liberia	SG	Siagapore		

JE08 Rec'd PCT/PTO 0 7 AUG 2001

WO 00/46306

5

10

PCT/Z:A:00/00019

TIMBER PROCESS AND PRODUCT

INTRODUCTION

This invention relates to a timber process and product. More particularly this invention relates to a process for manufacturing so-called particle board or chipboard, and to a timber product in the form of such particle board or chipboard when manufactured by or from the aforementioned process.

BACKGROUND TO THE INVENTION

- It is known in the manufacture of particle board or chipboard (hereinafter referred to as "chipboard") that a urea-formaldehyde resin (hereinafter referred to as "UF") is used as a binder or adhesive to bond the particles or chips of wood.
- Typically such binders contain approximately 55% to 60% formaldehyde (in moles) but because of recent awareness of the health problems associated with the use of formaldehyde, the amount of formaldehyde in such resins is generally being reduced. Hence the amount of formaldehyde in the aforementioned resins has been reduced to approximately 50% or less (in moles).

WO 00/46306 PCT/ZA60/60019

The aforementioned resins need to be cured, and the curing process is accelerated by heating in a press under pressure i.e. heat is applied by hot metal platens on both sides of a so-called mat of glued chips. Such chipboard pressing takes place either in a batch-type (using daylight presses) or in a continuous process i.e. using continuous (for example roller) presses.

It is also known in the chipboard industry that methyl di-isocyanate (hereinafter referred to as "MDI") may be added to the aforementioned type of resin to hasten the curing process i.e. to effectively increase the speed of the curing process and hence to reduce the curing time. However, because of the high cost of MDI and the amount required to effectively hasten the curing process, the use of MDI is not cost-effective on an industrial scale.

OBJECTS OF THE INVENTION

10

15

It is accordingly a general object of the present invention to provide an improved binding mixture for chipboard manufacture.

WO 00/46306

It is also an object of the present invention to provide an improved process in which such improved mixture is used, which is both cost-effective and which increases the efficiency and rate of curing of the binding mixture.

5

It is a further object of the invention that the aforementioned binding mixture and process will lead to an increase in productivity or production flowing from shorter curing periods resulting from use of the aforementioned binding mixture.

10

15

SUMMARY OF THE INVENTION

According to one aspect of the present invention, there is provided a binding mixture for use in manufacturing chipboard, the mixture including an effective amount of MDI and one or more polyurethane catalyst(s) being selected from the following:

- (a) one or more amine compound(s) including aliphatic and aromatic tertiary amine derivatives of phenols, esters, ethers, alkenes and/or alcohols; or
- one or more organometallic compound(s) of tin, bismuth, zinc, iron and/or alkali metal salt(s); or
 - (c) suitable mixtures of (a) and (b) above.

The MDI may or may not be water-emulsifiable, and the or each polyurethane catalyst(s) may or may not be (a) delayed-action catalyst(s).

To the mixture may be added an effective amount of toluene diisocyanate ("TDI") and/or one or more internal wetting and release agents.

The aforementioned mixture(s) may of course include a suitable amount

of urea-formaldehyde resin which may or may not have suitable
quantities of polyol(s) added thereto.

The amount of formaldehyde in the aforementioned urea-formaldehyde resin may preferably be approximately 50% (in moles) i.e. may be less than, equal to, or more than 50% (in moles).

By using a catalyst as aforesaid, the effective amount of MDI required is reduced relative to the amounts known in the prior art to be sufficient to hasten the curing process of the mixture.

20

15

Suitable amines or amine compounds may be selected from the following:

2-dimethyl ethanolamine (hereinafter referred to as "DMEA");
di-amino bicyclo-octane (hereinafter referred to as "DABCO"); and
N,N-dimethyl cyclohexylamine (hereinafter referred to as "DMCHA").

- Suitable organometallic tin-based compounds may be selected from the following:
 - stannous octoate, dibutyl tin dilaurate, dibutyl tin mercaptide, dibutyl tin thiocarboxylate, and dioctyl tin thiocarboxylate.
- 10 Other suitable organometallic compounds may include ferric acetylacetonate.

Suitable alkali metal salts may be selected from the following: calcium carbonate, salts of carbonic acid, and salts of acetic acid.

15

One supplier of the above catalysts (as mixtures or single compounds) is Air Products. South Africa, and the catalysts may be identified inter alia by the following trade marks/brands and/or acronyms, respectively:

10

CHEMICAL BRAND NAME	ACTIVE INGREDIENT(S)
DMEA	2-Dimethyl ethanolamine
DABCO	Di-amino bicyclo-octane
POLYCAT 8 (DMCILA)	N.N-dimethyl cyclobexylamine
DABCO R-8020	Triethylenediamine and Dimethylethanolamine
DABCO DC-1	Tin and amine complexes
DABCO DC-2	Tin and amine complexes
DABCO K-15	Potassium octate and diethylene glycol
DABCO TMR 2	Quaternary ammonium salt in ethylene
THORCAT 401	Di-N-butyltindilaurate

When used with one or more of the above catalysts, the amount of MDI required to effect a suitable hastening of the curing process may preferably be in the range of about 0.1% to 1.9% on bone dry wood (hereinafter referred to as "BDW").

According to another aspect of the present invention, there is provided an additive for a binding mixture for use in manufacturing chipboard, the additive including an effective amount of MDI and a catalyst, each as indicated above, and as otherwise described herein.

According to a further aspect of the present invention, there is provided a process for manufacturing chipboard, the process including the steps of

adding to or using in a binding mixture consisting of urea-formaldehyde resin, an effective amount of MDI and a catalyst, each catalyst being as indicated above, or as otherwise herein described, or an additive, respectively, as herein described, and suitably mixing the binding mixture with wood particles and/or chips.

DETAILED DESCRIPTION OF THE INVENTION

The invention will now be described in greater detail by way of nonlimiting example(s), with reference to the following:

1. LABORATORY TESTS

Laboratory tests were carried out by way of reasonable technical trials,

by personnel of the applicant's wholly owned subsidiary namely Sappi

Timber Industries (Proprietary) Limited on wood particles and chips as used for manufacturing chipboard in the factories of the aforementioned company.

Using the aforementioned raw materials, binder mixtures of ureaformaldehyde resin as typically used in the aforementioned company's production facilities were applied to the aforementioned particle chips, WO 00/46306 PCT/ZA00/00019

and compared with urea-formaldehyde mixtures including MDI, and further compared with mixtures of urea-formaldehyde with MDI and various catalysts as set out above.

- The resulting mixtures of particles/chips and binder mixtures were pressed in a laboratory scale press to simulate plant production conditions, and curing times were measured. In the binding mixtures that did not include a catalyst, longer curing times were observed.
- Details of the mixtures used and the corresponding results are set out in Table 1 hereafter:

15

20

25

30

35

TABLE 1

	MIXTURE ADDED TO UF RESIN	INCREASE IN PRODUCTION SPEED (%)
1.4 °	I + RELEASE AGENT % (on BDW) of MDI + 0.5 % (on UF solids) Internal Release and Wetting Agent	34.6
MO)	DIFIED MDI	
(a)	1.4% (on BDW) MDI modified with PPG diol MDI pre-polymer	44.3
(p) ·	1.4% (on BDW) MDI modified with PPG Triol MDI pre-polymer	44.3
(c <u>)</u>	1.4% (on BDW) MDI modified with TDI	44.3
(d)	1.4% (on BDW) MDI modified with PPG Triol TDI pre-polymer	42.4

Table 1 (Contd)

1 10	ie I (Conta)	
CAT	TALYSTS	
(a)	1.4% (on BDW) MDI modified with PPG Triol MDI pre-polymer + 0.1% DABCO TMR 2 catalyst	45.8
(b)	1.4% (on BDW) MDI modified with PPG Triol MDI pre-polymer + 0.1% (on UF mass) DABCO K 15 catalyst	44.3
(c)	1.4% (on BDW) MDI modified with PPG Triol MDI pre-polymer + 0.1% (on UFmass) DABCO DC 2 catalyst	44.3
(d)	1.2% (on BDW) MDI modified with PPG Triol MDI pre-polymer + 0.1% (on UFmass) DMCHA catalyst	42.3
(e)	(1.2% (on BDW) MDI modified with PPG Triol MDI pre-polymer + 0.1% (on UF mass) DABCO R8020 catalyst	42.3
(f)	1.2% (on BDW) MDI modified with PPG Triol MDI pre-polymer + 0.1% (on UF mass) Thorcat catalyst	40.0
(g)	1.4% (on BDW) MDI modified with Polyethylene glycol MDI pre- polymer + 0.1% (on UF mass) DABCO DC 2 catalyst	42.8
(b)	0.5% (on BDW) MDI + 1.1% (on UF mass) DMEA catalyst	33.3
(i)	0.5% (on BDW) water emulsified MDI + 1.1% (on UF mass) DMEA catalyst	33.3
	<u></u>	

In the aforementioned table, the brand name Daltolac R130 is a brand name for polyether polyol, which is sold by ICI (Imperial Chemical Industries). Similarly PPG diol MDI Pre-Polymer is the brand name for polypropylene glycol diol MDI pre-polymer and PPG triol TDI Pre-Polymer is the brand name for polypropylene glycol triol TDI pre-polymer.

The curing times for mixtures where typically 0.1% to 1.9% MDI and one or more of the abovementioned catalysts were added (on BDW), were the shortest.

10

5

The results of the above tests indicated that in all cases the binding mixtures with MDI and one or more catalysts resulted in a shorter curing period with the same or an increased binding strength.

It was also found that the use of amines as catalysts alone resulted in the least costly mixture and hence the most cost-effective process(es).

2. PRODUCTION-PLANT TRIALS

The aforementioned tests were repeated by way of reasonable technical trials, on two different production lines namely one using a single daylight press and the other using a continuous press. Details of the

5

10

mixtures used and the corresponding results are set out in Table 2 hereunder:

TABLE 2

MIXTURE ADDED TO UF RESIN	INCREASE IN PRODUCTION SPEED
CONTINUOUS PRESS	(%)
WHITE RIVER FACTORY	
0.5% (on BDW) waster emulsifiable MDI + 1.1% (on UF mass) + DMEA catalyst	14.3

The abovementioned production-line tests confirmed the aforementioned laboratory results, with improvements in or increased curing times of up to approximately 14 to 24%. The applicant believes that it may be possible to achieve greater improvements than the aforementioned.

It will therefore be seen from the aforementioned that a considerable improvement in curing times and hence in productivity may be possible by using the aforementioned invention. Such improvement also appears to be cost-effective relative to increased productivity and production on an industrial scale.

WO 00/46306 PCT/ZAG0/00019

Although certain embodiments only of the invention have been described herein, it will be apparent to any person skilled in the art that other variations and/or modifications of the invention are possible. Such variations and/or modifications are therefore to be considered as falling within the spirit and scope of the invention as claimed hereinafter.

10

15

20

CLAIMS

10

20

- A binding mixture for use in manufacturing chipboard, the mixture
 including an effective amount of methyl di-isocyanate ("MDI") and
 one or more polyurethane catalyst(s) being selected from the following:
 - (a) one or more amine compound(s) including aliphatic and aromatic tertiary amine derivatives of phenols, esters, ethers, alkenes and/or alcohols; or
 - (b) one or more organometallic compounds of tin, bismuth, zinc, iron, and/or alkali metal salt(s); or
 - (c) suitable mixtures of (a) and (b) above.
- 2. A binding mixture as claimed in claim 1, wherein the MDI is wateremulsifiable.
 - 3. A binding mixture as claimed in either claim 1 or claim 2, wherein the or each polyurethane catalyst(s) is/are (a) delayed-action catalyst(s).
 - A binding mixture as claimed in any one of the preceding claims, wherein an effective amount of toluene di-isocyanate ("TDI") is added to the MDI.

 A binding mixture as claimed in any one of the preceding claims, wherein one or more internal wetting and release agents is/are added to the mixture.

5

- A binding mixture as claimed in any one of the preceding claims,
 wherein a suitable amount of urea-formaldehyde resin is added.
- 7. A binding mixture as claimed in claim 6, wherein a suitable quantity of or more one polyol(s) is/are added.
 - 8. A binding mixture as claimed in either claim 6 or claim 7, wherein the amount of formaldehyde in the urea-formaldehyde resin may be approximately 50% (in moles).

15

20

9. A binding mixture as claimed in any one of the preceding claims, wherein the or each suitable amine(s) or amine compound(s) are selected from the following:

2-dimethyl ethanolamine ("DMEA");

di-amino bicyclo-octane ("DABCO"); and

N,N-dimethyl cyclohexylamine ("DMCHA").

- 10. A binding mixture as claimed in any one of the preceding claims, wherein the or each suitable organometallic tin-based compound(s) is/are selected from the following:
 - Stannous octoate, dibutyl tin dilaurate, dibutyl tin mercaptide, dibutyl tin thiocarboxylate, and dioctyl tin thiocarboxylate.
- 11. A binding mixture as claimed in any one of the preceding claims, wherein the suitable organometallic compounds include ferric acetylacetonate.

10

5

- 12. A binding mixture as claimed in any one of the preceding claims, wherein the suitable alkali metal salts are selected from the following:
 - calcium carbonate, salts of carbonic acid, and salts of acetic acid.

15

13. A binding mixture as claimed in any one of the preceding claims, wherein the amount of MDI required to effect a suitable hastening of the curing process is in the range of from about 0.1% to 1.9% of bone dry wood ("BDW").

20

 A binding mixture substantially as herein described and/or exemplified. WO 00/46306 PCT/ZA00/00019

15. An additive for a binding mixture for use in manufacturing chipboard, the additive including an effective amount of MDI and a catalyst, each catalyst being as claimed in any one of the preceding claims.

5

- 16. An additive for a binding mixture for use in making chipboard, substantially as herein described and/or exemplified.
- 17. A process for manufacturing chipboard, the process including the steps of adding to or using in a binding mixture an effective amount of MDI and a catalyst, each catalyst being as claimed in any one of claims 1 to 14, and suitably mixing the binding mixture with wood particles and/or chips.
- 18. A process for manufacturing chipboard, the process including the steps of adding to or using in a binding mixture an effective amount of an additive as claimed in either claim 15 or claim 16, and suitably mixing the binding mixture with wood particles and/or chips.

20

 A process for manufacturing chipboard, substantially as herein described and/or exemplified.